

## **Description**

The VSM2006NE uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

#### **General Features**

● V<sub>DS</sub> = 20V,I<sub>D</sub> =7A

 $R_{DS(ON)}$  < 27m $\Omega$  @  $V_{GS}$ =2.5V

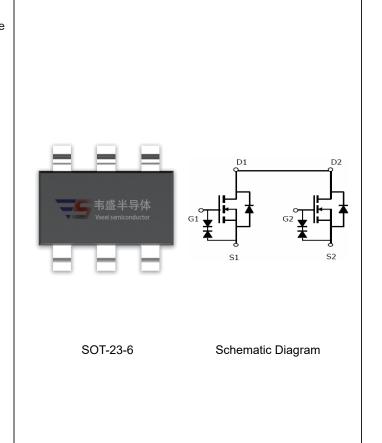
 $R_{DS(ON)}$  < 21m $\Omega$  @  $V_{GS}$ =4.5V

ESD Rating: 2000V HBM

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

## **Application**

- ●PWM application
- Load switch



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM2006NE-S6	VSM2006NE	SOT-23-6	Ø330mm	12mm	3000 units

Absolute Maximum Ratings (T<sub>A</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	20	V	
Gate-Source Voltage	Vgs	±12	V	
Drain Current-Continuous	I <sub>D</sub>	7	Α	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	30	Α	
Maximum Power Dissipation	P <sub>D</sub>	1.25	W	
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$ C	

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	100	°C/W



# Electrical Characteristics ( $T_A$ =25 $^{\circ}$ C unless otherwise noted)

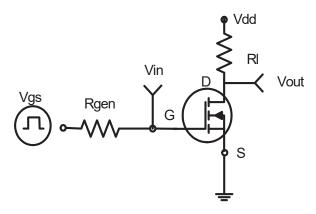
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	20		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm10V, V_{DS}=0V$	-	-	±10	μA
On Characteristics (Note 3)			•			l
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	0.55	0.7	0.95	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =6.5A	-	15	21	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =5.5A	-	20	27	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =7A	-	20	-	S
Dynamic Characteristics (Note4)			•			l
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V,	-	1150	-	PF
Output Capacitance	C <sub>oss</sub>		-	185	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	145	-	PF
Switching Characteristics (Note 4)						l
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =10V,R <sub>L</sub> =1.35Ω	-	6		nS
Turn-on Rise Time	t <sub>r</sub>		-	13		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =5 $V$ , $R_{GEN}$ =3 $\Omega$	-	52		nS
Turn-Off Fall Time	t <sub>f</sub>		-	16		nS
Total Gate Charge	Qg	\/ 40\/  74	-	15		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=10V,I_{D}=7A,$	-	0.8	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =4.5V	-	3.2	-	nC
<b>Drain-Source Diode Characteristics</b>				ı		
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =1A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	7	Α

#### Notes:

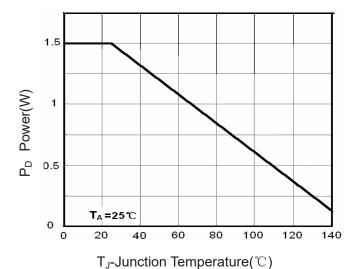
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production



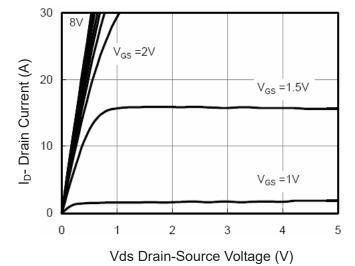
## **Typical Electrical and Thermal Characteristics**



**Figure 1:Switching Test Circuit** 



**Figure 3 Power Dissipation** 



**Figure 5 Output Characteristics** 



Figure 2:Switching Waveforms

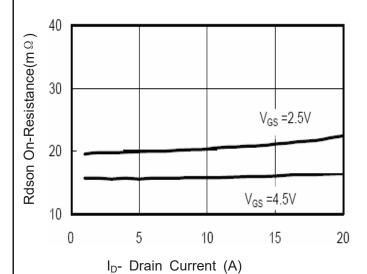


Figure 6 Drain-Source On-Resistance

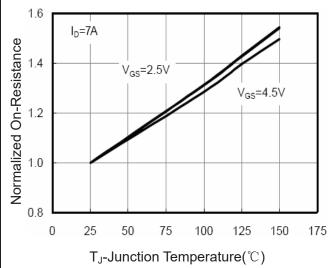
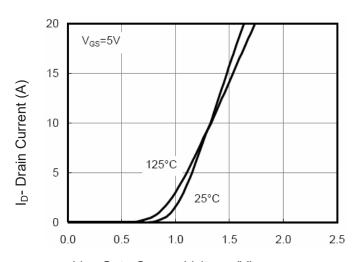


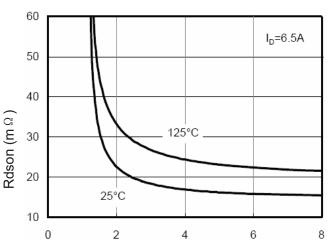
Figure 8 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V)

**Figure 7 Transfer Characteristics** 



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

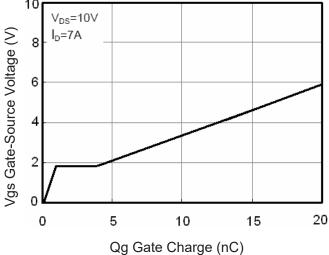
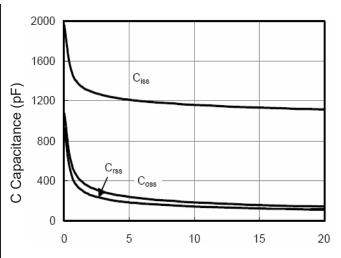
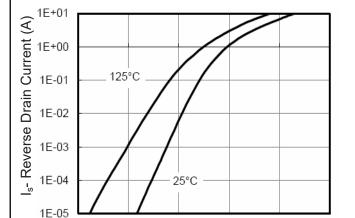


Figure 11 Gate Charge



Vds Drain-Source Voltage (V)

Figure 8 Capacitance vs Vds



Vds Drain-Source Voltage (V)

0.4

0.2

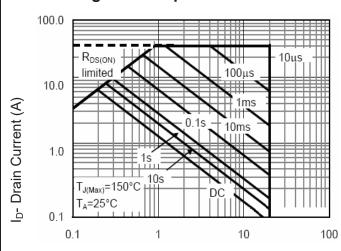
0.0

Figure 10 Capacitance vs Vds

0.6

8.0

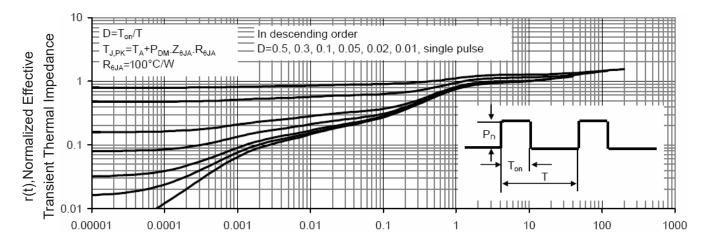
1.0



Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area





**Figure 14 Normalized Maximum Transient Thermal Impedance** 

Square Wave Pluse Duration(sec)